SCAS173A - JULY 1990 - REVISED APRIL 1996

		/		
<ul> <li>Members of the Texas Instruments Widebus ™ Family</li> </ul>	74ACT16		DL P	PACKAGE PACKAGE
<ul> <li>Inputs Are TTL-Voltage Compatible</li> </ul>			<u> </u>	
<ul> <li>Flow-Through Architecture Optimizes</li> <li>PCB Layout</li> </ul>	1DIR [ 1B1 [	$1 \\ 2$		] 1 <u>0</u> E ] 1A1
<ul> <li>Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise</li> </ul>	1B2	1	46	1A2 GND
<ul> <li>EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) 1-µm Process</li> </ul>	1B3 [ 1B4 [		43	1A3 1A4
<ul> <li>500-mA Typical Latch-Up Immunity at 125°C</li> </ul>	1B5 [	7 8	41	V <sub>CC</sub>   1A5
<ul> <li>Packaged in Plastic 300-mil Shrink Small-Outline (DL) Packages Using 25-mil</li> </ul>	1B6 [ GND [ 1B7 [	10	39	] 1A6 ] GND ] 1A7
Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center Spacings		13	36	] 1A8 ] 2A1
description	5	14 15 16	34	] 2A2 ] GND ] 2A3
The 'ACT16640 are inverting 16-bit transceivers designed for asynchronous communication	2B4	17	32	2A4
between data buses.	2B5		30	V <sub>CC</sub>   2A5
These devices can be used as two 8-bit transceivers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or	2B6 [ GND [ 2B7 [	21	28	] 2A6 ] GND ] 2A7

transceivers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (1DIR and 2DIR) inputs. The output-enable (1OE and 2OE) inputs can be used to disable the device so that the buses are effectively isolated.

The 74ACT16640 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

2B8 23

2DIR 1 24

26 2A8

25 20E

The 54ACT16640 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The 74ACT16640 is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.

(each section)							
INF	PUTS						
OE	DIR	OPERATION					
L	L	B data to A bus					
L	Н	A data to B bus					
н	Х	Isolation					

#### FUNCTION TABLE (each section)



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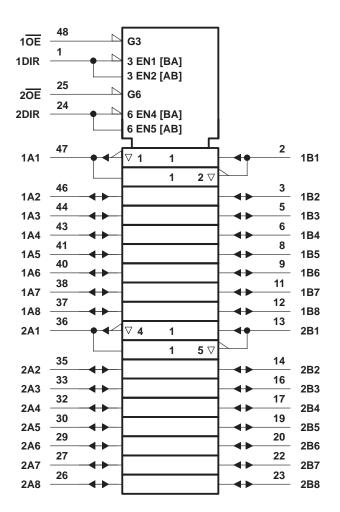
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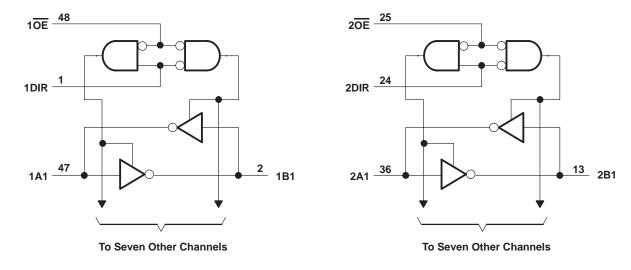
SCAS173A - JULY 1990 - REVISED APRIL 1996

## logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)





SCAS173A - JULY 1990 - REVISED APRIL 1996

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$	2 + 0.5 V 2 + 0.5 V ±20 mA ±50 mA ±50 mA ±400 mA 1.2 W
Storage temperature range, $T_{stg}$	

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

#### recommended operating conditions (see Note 3)

		54ACT16640		74ACT16640		40		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2		h	2			V
VIL	Low-level input voltage		ľn,	0.8			0.8	V
VI	Input voltage	0	R	VCC	0		VCC	V
VO	Output voltage	0	1	VCC	0		VCC	V
ЮН	High-level output current		50	-24			-24	mA
IOL	Low-level output current	02	~	24			24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0		10	0		10	ns/V
TA	Operating free-air temperature	-55		125	-40		85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.



SCAS173A - JULY 1990 - REVISED APRIL 1996

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER				T,	T <sub>A</sub> = 25°C         54ACT16640         74ACT           MIN         TYP         MAX         MIN         MAX         MIN		74ACT	16640				
		TEST CONDITIONS	Vcc	MIN			MAX	MAX UNIT				
			4.5 V	4.4			4.4		4.4			
		I <sub>OH</sub> = -50 μA	5.5 V	5.4			5.4		5.4			
∨он			4.5 V	3.94			3.8		3.8		V	
		I <sub>OH</sub> = -24 mA	5.5 V	4.94			4.8		4.8			
		I <sub>OH</sub> = -75 mA <sup>†</sup>	5.5 V				3.85	n'i	3.85			
			4.5 V			0.1		0.1		0.1	0.1	
VOL		I <sub>OL</sub> = 50 μA	5.5 V			0.1	4	<b>6</b> 0.1		0.1	]	
			4.5 V			0.36	6	0.44		0.44	V	
		$I_{OL} = 24 \text{ mA}$	5.5 V			0.36	na	0.44		0.44		
		I <sub>OL</sub> = 75 mA <sup>†</sup>	5.5 V				40	1.65		1.65		
lj	Control inputs	$V_{I} = V_{CC} \text{ or } GND$	5.5 V			±1	Y	±1		±1	μA	
loz‡	A or B ports	$V_{O} = V_{CC} \text{ or } GND$	5.5 V			±0.5		±5		±5	μA	
ICC	-	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			8		80		80	μA	
∆ICC§		One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND	5.5 V			0.9		1		1	mA	
Ci	Control inputs	$V_{I} = V_{CC}$ or GND	5 V		4.5						pF	
Cio	A or B ports	$V_{O} = V_{CC} \text{ or } GND$	5 V		16						pF	

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

<sup>‡</sup> For I/O ports, the parameter IOZ includes the input leakage current.

\$ This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

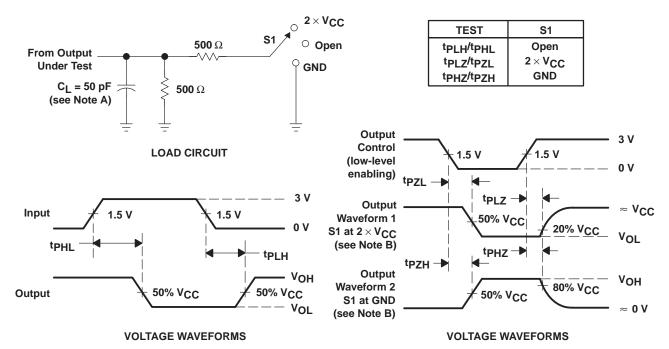
	FROM	то	Т	ן = 25°C	;	54ACT	16640	74ACT	16640	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	ns
<sup>t</sup> PLH		B or A	2.2	6	8.3	2.2	9.1	2.2	9.1	
<sup>t</sup> PHL	A or B		4.1	7.6	9.3	4.1	10.5	4.1	10.5	ns
<sup>t</sup> PZH		A an D	2.7	6.9	8.9	2.7	9.8	2.7	9.8	
<sup>t</sup> PZL	ŌĒ	A or B	3.5	8.2	10.4	3.5	11.5	3.5	11.5	ns
<sup>t</sup> PHZ	OE	A or B	6.1	9.4	11.4	6.1	12.5	6.1	12.5	ns
<sup>t</sup> PLZ	UE UE	AUD	5.5	8.7	10.3	<b>\$</b> 5.5	11	5.5	11	115

## operating characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

PARAMETER		TEST CON	TYP	UNIT		
	Dower discipation conscitance per transcriver	Outputs enabled	$C_{1} = 50 \text{ pc}$	f = 1 MHz	52	۳E
Cp	od Power dissipation capacitance per transceiver	Outputs disabled	C <sub>L</sub> = 50 pF,		9	р⊦



SCAS173A - JULY 1990 - REVISED APRIL 1996



## PARAMETER MEASUREMENT INFORMATION

- NOTES: A. CL includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub> = 3 ns, t<sub>f</sub> = 3 ns.
  - D. The outputs are measured one at a time with one input transition per measurement.

#### Figure 1. Load Circuit and Voltage Waveforms



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